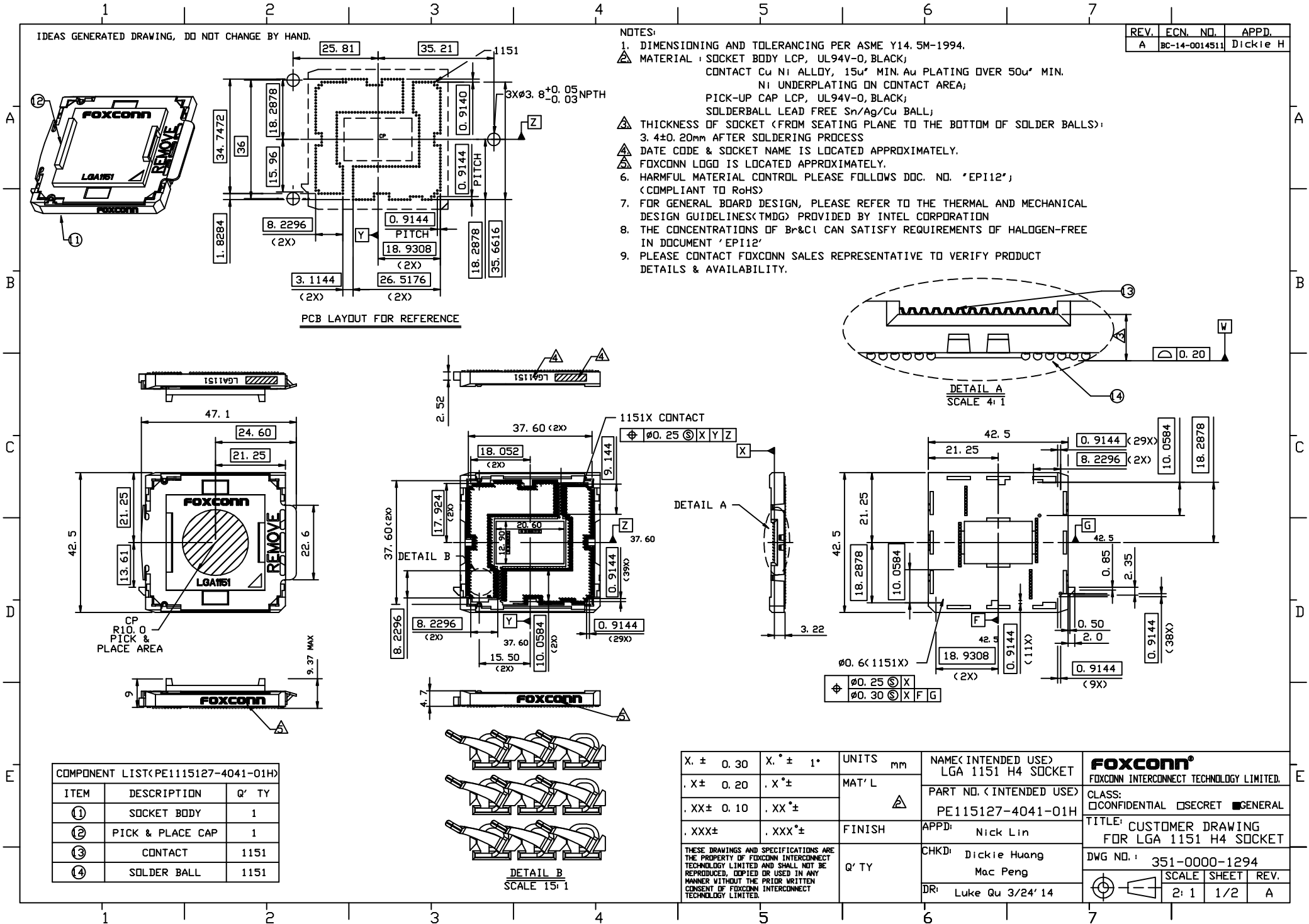


IDEAS GENERATED DRAWING, DO NOT CHANGE BY HAND.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. MATERIAL: SOCKET BODY LCP, UL94V-0, BLACK;  
CONTACT Cu Ni ALLOY, 15u" MIN. Au PLATING OVER 50u" MIN.  
NI UNDERPLATING ON CONTACT AREA;  
PICK-UP CAP LCP, UL94V-0, BLACK;  
SOLDERBALL LEAD FREE Sn/Ag/Cu BALL;
3. THICKNESS OF SOCKET (FROM SEATING PLANE TO THE BOTTOM OF SOLDER BALLS):  
3.4±0.20mm AFTER SOLDERING PROCESS
4. DATE CODE & SOCKET NAME IS LOCATED APPROXIMATELY.
5. FOXCONN LOGO IS LOCATED APPROXIMATELY.
6. HARMFUL MATERIAL CONTROL PLEASE FOLLOWS DDC. NO. 'EPI12';  
(COMPLIANT TO RoHS)
7. FOR GENERAL BOARD DESIGN, PLEASE REFER TO THE THERMAL AND MECHANICAL DESIGN GUIDELINES (TMDG) PROVIDED BY INTEL CORPORATION
8. THE CONCENTRATIONS OF Br&Cl CAN SATISFY REQUIREMENTS OF HALOGEN-FREE IN DOCUMENT 'EPI12'
9. PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY.

REV.	ECN. NO.	APPD.
A	BC-14-0014511	Dickie H

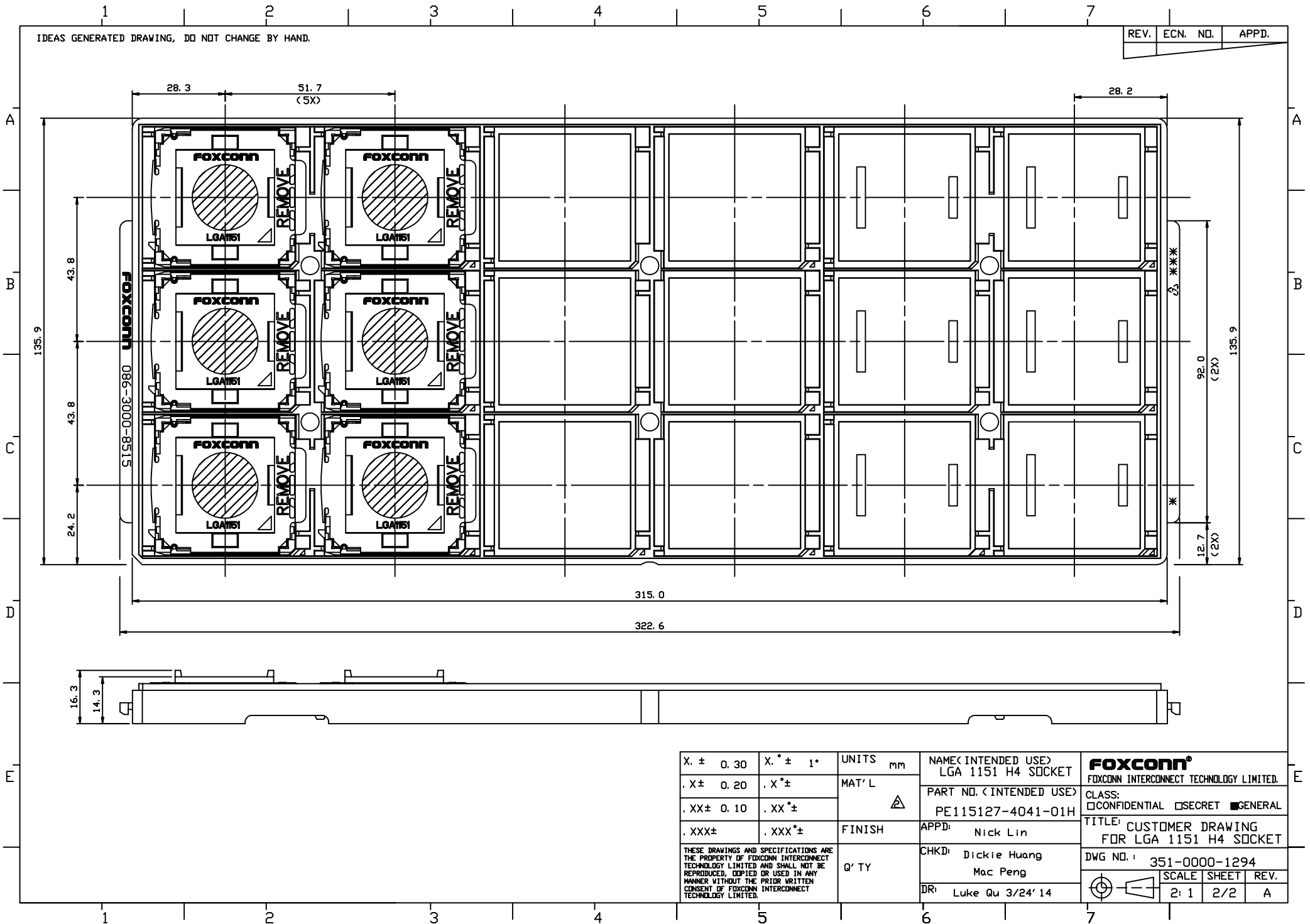


COMPONENT LIST(PE115127-4041-01H)		
ITEM	DESCRIPTION	Q' TY
①	SOCKET BODY	1
②	PICK & PLACE CAP	1
③	CONTACT	1151
④	SOLDER BALL	1151

X. ± 0.30	X. ° ± 1°	UNITS	mm	NAME (INTENDED USE)	<b>FOXCONN</b> FOXCONN INTERCONNECT TECHNOLOGY LIMITED. CLASS: <input type="checkbox"/> CONFIDENTIAL <input type="checkbox"/> SECRET <input checked="" type="checkbox"/> GENERAL
. X ± 0.20	. X ° ±	MAT'L		LGA 1151 H4 SOCKET	
. XX ± 0.10	. XX ° ±			PART NO. (INTENDED USE)	TITLE: CUSTOMER DRAWING FOR LGA 1151 H4 SOCKET
. XXX ±	. XXX ° ±	FINISH		APPD: Nick Lin	DWG NO.: 351-0000-1294
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				DR: Luke Qu 3/24' 14	2: 1 1/2 A

IDEAS GENERATED DRAWING, DO NOT CHANGE BY HAND.

REV.	ECN. NO.	APPD.
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X. ± 0.30	X. ° ± 1°	UNITS	mm	NAME (INTENDED USE)	LGA 1151 H4 SOCKET	<b>FOXCONN</b> FOXCONN INTERCONNECT TECHNOLOGY LIMITED.
. X ± 0.20	. X ° ±	MAT'L		PART NO. (INTENDED USE)	PE115127-4041-01H	
. XX ± 0.10	. XX ° ±			APPD:	Nick Lin	TITLE: CUSTOMER DRAWING FOR LGA 1151 H4 SOCKET
. XXX ±	. XXX ° ±	FINISH		CHKD:	Dickie Huang Mac Peng	DWG NO.: 351-0000-1294
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						DR: